

PHOTOCOUPLER

PS9552,PS9552L1,PS9552L2,PS9552L3

2.5 A OUTPUT CURRENT, HIGH CMR IGBT GATE DRIVE PHOTOCOUPLER 8-PIN DIP PHOTOCOUPLER

-NEPOC Series-

DESCRIPTION

The PS9552, PS9552L1, PS9552L2 and PS9552L3 are optically coupled isolators containing a GaAlAs LED on the input side and a photo diode, a signal processing circuit and a power output transistor on the output side on one chip.

The PS9552 Series is designed specifically for high common mode transient immunity (CMR), high output current and high switching speed.

The PS9552 Series is suitable for driving IGBTs and MOS FETs.

The PS9552 Series is in a plastic DIP (Dual In-line Package).

The PS9552L1 is lead bending type for long creepage distance.

The PS9552L2 is lead bending type for long creepage distance (Gull-wing) for surface mount.

The PS9552L3 is lead bending type (Gull-wing) for surface mounting.

FEATURES

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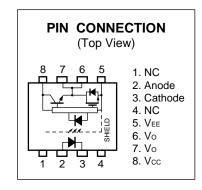
- Long creepage distance (8 mm MIN.: PS9552L1, PS9552L2)
- Large peak output current (2.5 A MAX., 2.0 A MIN.)
- High speed switching (tPLH/tPHL = 0.5 μ s MAX.)
- UVLO (Under Voltage Lock Out) protection with hysteresis
- High common mode transient immunity (CMH, CML = $\pm 25 \text{ kV}/\mu \text{s}$ MIN.)
 - Ordering number of tape product: PS9552L2-E3: 1 000 pcs/reel

: PS9552L3-E3: 1 000 pcs/reel

- Safety standards
 - UL approved: File No. E72422
 - CSA approved: No. CA 101391
 - BSI approved: No. 8937, 8938
 - SEMKO approved: No. 615433
 - NEMKO approved: No. P06207243
 - DEMKO approved: No. 314091
 - FIMKO approved: No. FI 22827
 - DIN EN60747-5-2 (VDE0884 Part2) approved (Option)

APPLICATIONS

- IGBT, Power MOS FET Gate Driver
- Industrial inverter
- IH (Induction Heating)



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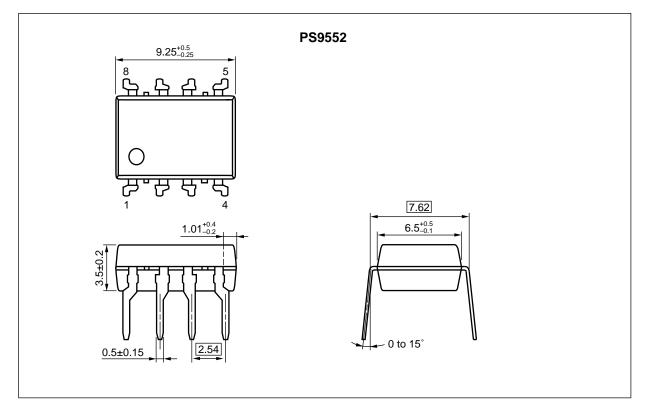
The mark <R> shows major revised points.

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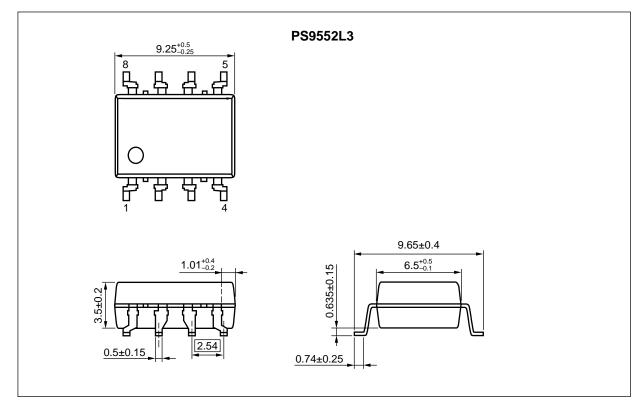
The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

PACKAGE DIMENSIONS (UNIT: mm)

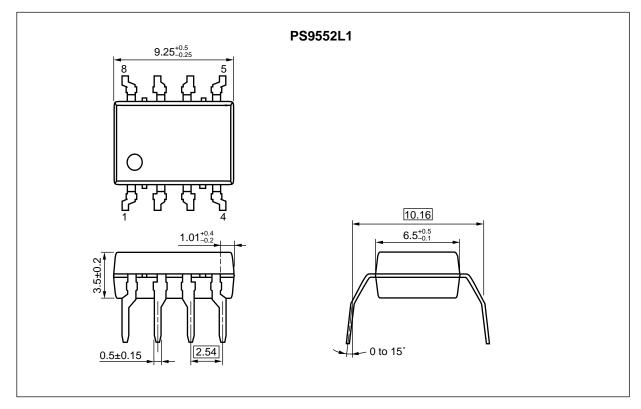
DIP Type



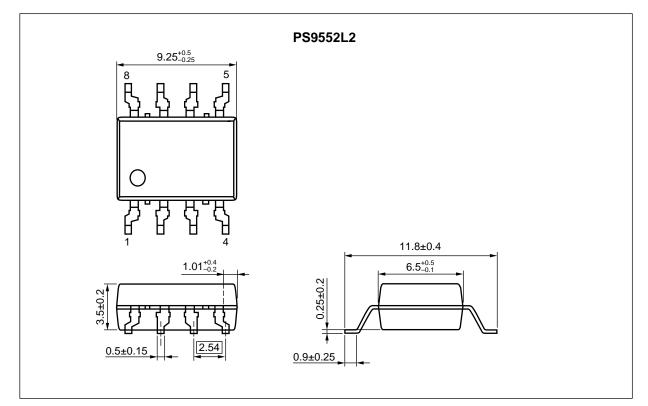
Lead Bending Type (Gull-wing) For Surface Mount



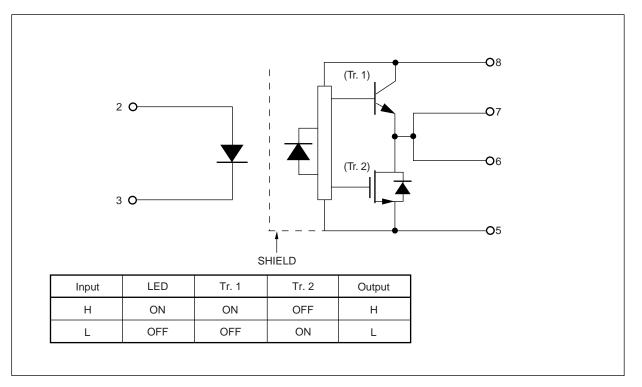
Lead Bending Type For Long Creepage Distance



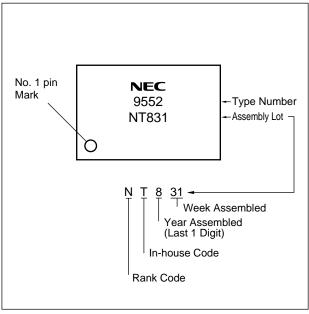
Lead Bending Type (Gull-wing) For Long Creepage Distance (Surface Mount)



FUNCTIONAL DIAGRAM



<R> MARKING EXAMPLE



PHOTOCOUPLER CONSTRUCTION

Parameter	PS9552, PS9552L3	PS9552L1, PS9552L2
Air Distance (MIN.)	7 mm	8 mm
Outer Creepage Distance (MIN.)	7 mm	8 mm
Isolation Distance (MIN.)	0.4 mm	0.4 mm

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number* ¹
PS9552	PS9552-AX	Pb-Free	Magazine case 50 pcs	Standard products	PS9552
PS9552L1	PS9552L1-AX	(Ni/Pd/Au)		(UL, CSA, BSI,	PS9552L1
PS9552L2	PS9552L2-AX			SEMKO, NEMKO,	PS9552L2
PS9552L3	PS9552L3-AX			DEMKO, FIMKO	PS9552L3
PS9552L2-E3	PS9552L2-E3-AX		Embossed Tape 1 000 pcs/reel	approved)	PS9552L2
PS9552L3-E3	PS9552L3-E3-AX				PS9552L3
PS9552-V	PS9552-V-AX		Magazine case 50 pcs	DIN EN60747-5-2	PS9552
PS9552L1-V	PS9552L1-V-AX			(VDE0884 Part2)	PS9552L1
PS9552L2-V	PS9552L2-V-AX			Approved (Option)	PS9552L2
PS9552L3-V	PS9552L3-V-AX				PS9552L3
PS9552L2-V-E3	PS9552L2-V-E3-AX		Embossed Tape 1 000 pcs/reel		PS9552L2
PS9552L3-V-E3	PS9552L3-V-E3-AX				PS9552L3

ORDERING INFORMATION

*1 For the application of the Safety Standard, following part number should be used.

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current	lf	25	mA
	Peak Transient Forward Current (Pulse Width < 1 μ s)	IF (TRAN)	1.0	A
	Reverse Voltage	VR	5	V
Detector	High Level Peak Output Current ^{*1}	Іон (реак)	2.5	A
	Low Level Peak Output Current ^{*1}	IOL (PEAK)	2.5	A
	Supply Voltage	(Vcc - Vee)	0 to 35	V
	Output Voltage	Vo	0 to Vcc	V
	Power Dissipation *2	Pc	250	mW
Isolation	Voltage ^{*3}	BV	5 000	Vr.m.s.
Total Pov	ver Dissipation *4	Р⊤	300	mW
Operating	g Frequency *5	f	50	kHz
Operating	g Ambient Temperature	TA	-40 to +100	°C
Storage	Temperature	Tstg	-55 to +125	°C

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

*1 Maximum pulse width = 10 μ s, Maximum duty cycle = 0.2%

- *2 Reduced to 4.8 mW/°C at $T_A = 70^{\circ}C$ or more.
- *3 AC voltage for 1 minute at $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-4 shorted together, 5-8 shorted together.
- *4 Reduced to 5.4 mW/°C at $T_A = 70$ °C or more.
- *5 IOH (PEAK) ≤ 2.0 A (≤ 0.3 μ s), IOL (PEAK) ≤ 2.0 A (≤ 0.3 μ s)

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage	(Vcc - Vee)	15		30	V
Forward Current (ON)	F (ON)	7	10	16	mA
Forward Voltage (OFF)	VF (OFF)	-2		0.8	V
Operating Ambient Temperature	TA	-40		100	°C

ELECTRICAL CHARACTERISTICS (TA = -40 to +100°C, Vcc = 15 to 30 V, IF (ON) = 7 to 16 mA, VF (OFF) = -2 to 0.8 V, VEE = GND, unless otherwise specified)

	Parameter	Symbol	Conditions	MIN.	TYP. ^{*1}	MAX.	Unit
Diode	Forward Voltage	VF	IF = 10 mA, TA = 25°C	1.3	1.65	2.1	V
	Input Capacitance	CIN	f = 1 MHz, VF = 0 V, TA = 25°C		60		pF
Detector	High Level Output Current	Іон	$V_0 = (V_{CC} - 4 V)^{*2}$	0.5	2.0		А
			$V_0 = (V_{CC} - 15 V)^{*3}$	2.0			
	Low Level Output Current	lol	Vo = (VEE + 2.5 V) ^{*2}	0.5	2.0		А
			Vo = (Vee + 15 V) *3	2.0			
	High Level Output Voltage	Vон	lo = -100 mA *4	Vcc-3.5	Vcc - 2.5	Vcc - 1.5	V
	Low Level Output Voltage	Vol	lo = 100 mA		0.1	0.5	V
	High Level Supply Current	Іссн	Vo = open, IF = 7 to 16 mA		2.0	5.0	mA
	Low Level Supply Current	Iccl	V_0 = open, V_F = -2 to +0.8 V		2.0	5.0	mA
	UVLO Threshold	Vuvlo+	Vo > 5 V, I⊧ = 10 mA	11.0	12.3	13.5	V
		Vuvlo-		9.5	10.7	12.0	
	UVLO Hysteresis	UVLOHYS	Vo > 5 V, I⊧ = 10 mA		1.6		V
Coupled	Threshold Input Current $(L \rightarrow H)$	IFLH	lo = 0 mA, Vo > 5 V		2.0	5.0	mA
	Threshold Input Voltage $(H \rightarrow L)$	Vfhl	lo = 0 mA, Vo < 5 V	0.8			V

***1** Typical values at $T_A = 25^{\circ}C$.

*2 Maximum pulse width = 50 μ s, Maximum duty cycle = 0.5%.

*3 Maximum pulse width = 10 μ s, Maximum duty cycle = 0.2%

*4 VoH is measured with the DC load current in this testing (Maximum pulse width = 2 ms, Maximum duty cycle = 20%).

SWITCHING CHARACTERISTICS (TA = -40 to +100°C, Vcc = 15 to 30 V, IF (ON) = 7 to 16 mA, VF (OFF) = -2 to 0.8 V, VEE = GND, unless otherwise specified)

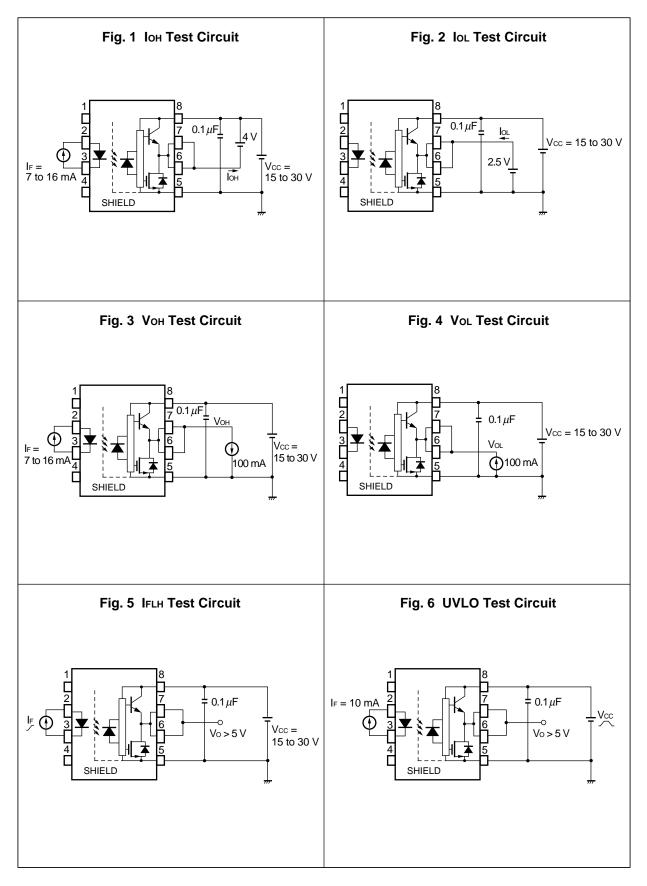
	Parameter	Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
	Propagation Delay Time (L \rightarrow H)	tрін	$R_g = 10 \ \Omega, \ C_g = 10 \ nF, \ f = 10 \ kHz,$	0.1	0.3	0.5	μS
<r></r>	Propagation Delay Time (H \rightarrow L)	tph∟	Duty Cycle = $50\%^{2}$, I _F = 7 to 16 mA	0.1	0.3	0.5	μS
	Pulse Width Distortion (PWD)	tphl-tplh				0.3	μS
	Propagation Delay Time (Difference Between Any Two Products)	tphl—tplh		-0.35		0.35	μS
	Rise Time	tr			0.1		μS
	Fall Time	tr			0.1		μS
	UVLO (Turn On Delay)	t uvlo on	Vo > 5 V, IF = 10 mA		0.8		μS
	UVLO (Turn Off Delay)	t uvlo off	Vo < 5 V, IF = 10 mA		0.6		μS
<r></r>	Common Mode Transient Immunity at High Level Output ^{*3}	CMH	$T_{A} = 25^{\circ}C, I_{F} = 10 \text{ to } 16 \text{ mA}, V_{CC} = 30 \text{ V},$ $V_{O \text{ (MIN.)}} = 26 \text{ V}, V_{CM} = 1.5 \text{ k V}$	25			kV/ <i>µ</i> s
<r></r>	Common Mode Transient Immunity at Low Level Output ^{*3}	CM∟	$T_{A} = 25^{\circ}C, I_{F} = 0 \text{ mA}, V_{CC} = 30 \text{ V}, V_{O (MAX.)} = 1 \text{ V}, V_{CM} = 1.5 \text{ k} \text{ V}$	25			kV/ <i>µ</i> s

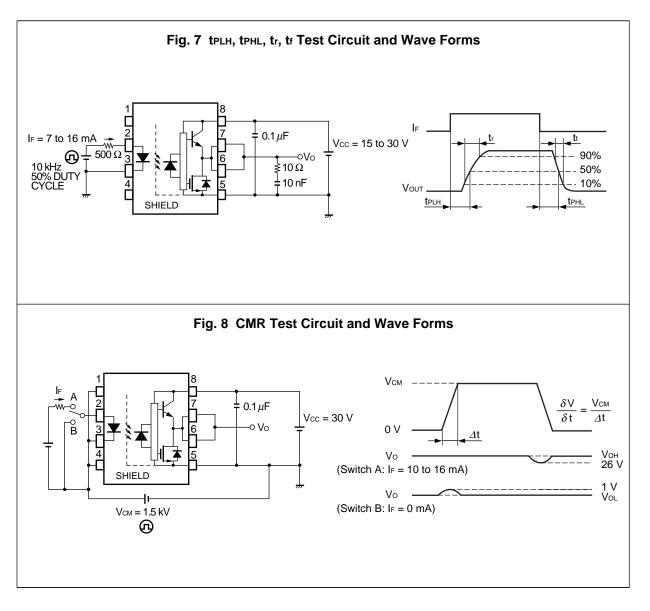
*1 Typical values at $T_A = 25^{\circ}C$.

*2 This load condition is equivalent to the IGBT load at 1 200 V/75 A.

*3 Connect pin 1 and pin 4 to the LED common.

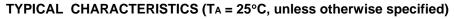
TEST CIRCUIT

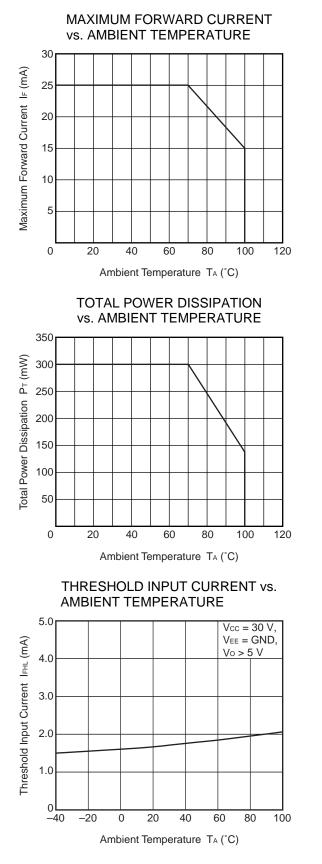




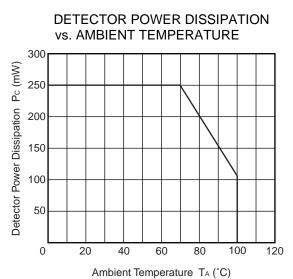
Remark CMR Test : Connect pin 1 and pin 4 to the LED common.

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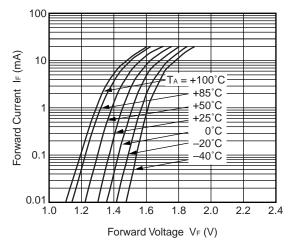




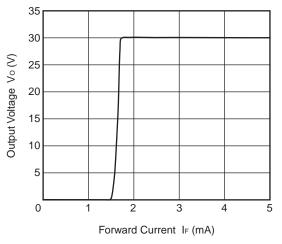
Remark The graphs indicate nominal characteristics.

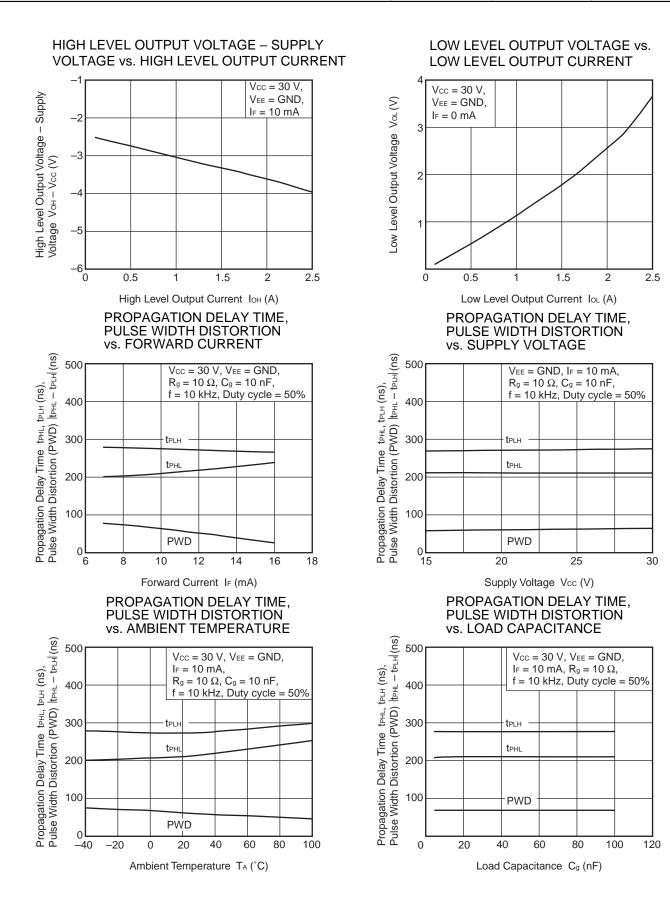


FORWARD CURRENT vs. FORWARD VOLTAGE



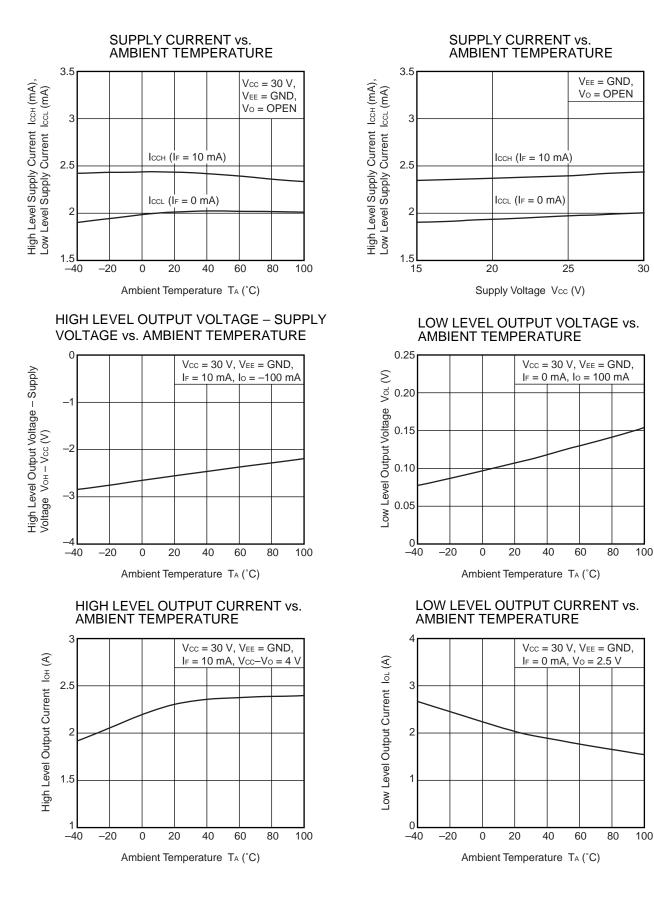
OUTPUT VOLTAGE vs. FORWARD CURRENT



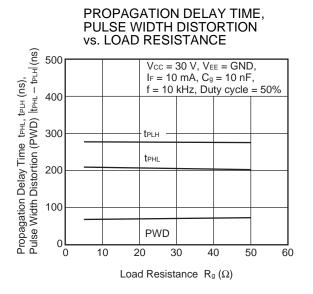




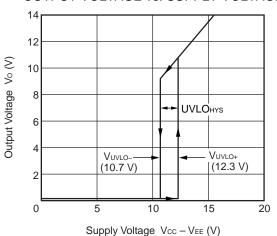
Data Sheet PN10589EJ05V0DS



Remark The graphs indicate nominal characteristics.

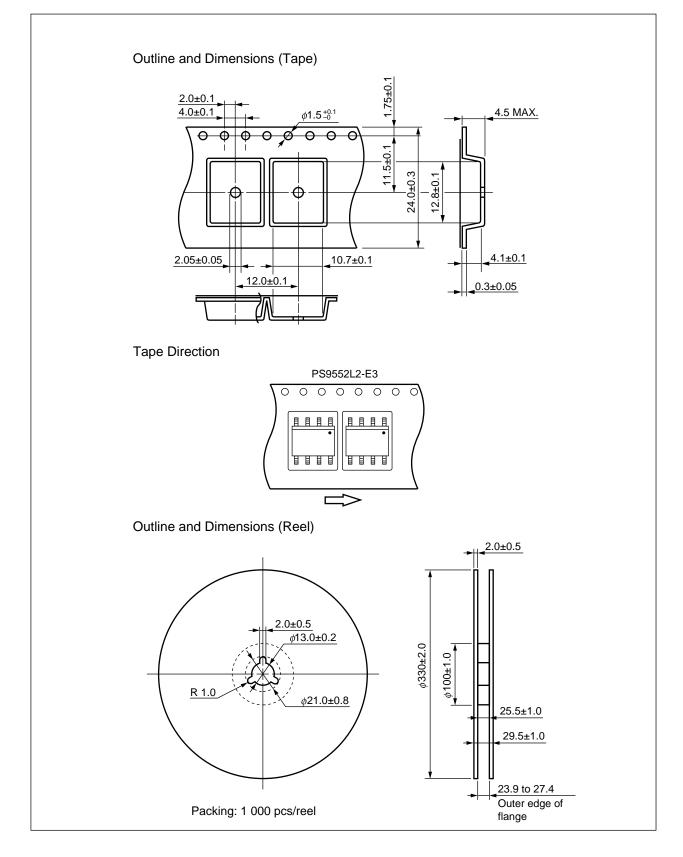


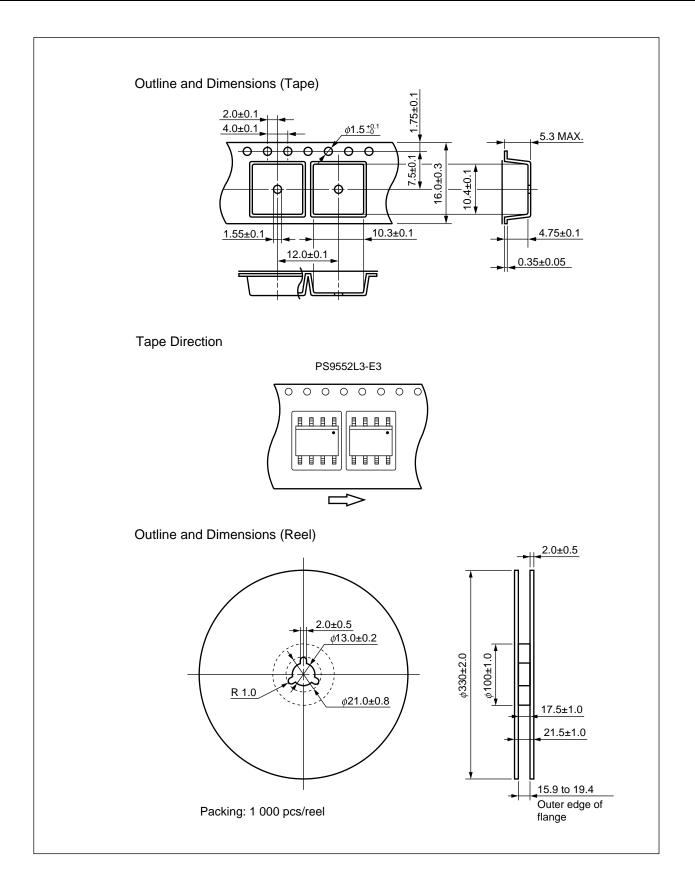
Remark The graphs indicate nominal characteristics.

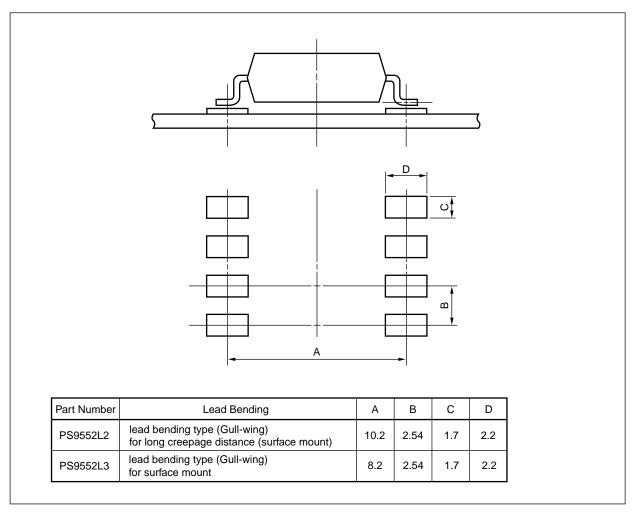


OUTPUT VOLTAGE vs. SUPPLY VOLTAGE

TAPING SPECIFICATIONS (UNIT: mm)







RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)

NOTES ON HANDLING

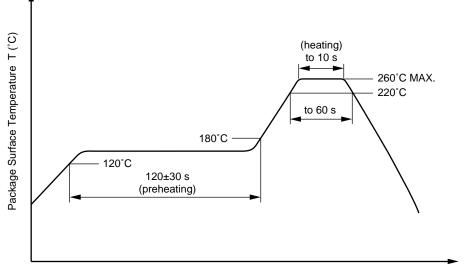
1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature
- Time of peak reflow temperature
- Time of temperature higher than 220°C
- Time to preheat temperature from 120 to 180°C
- Number of reflows
- Flux

260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



Time (s)

(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

Peak Temperature (lead part temperature)	350°C or below
Time (each pins)	3 seconds or less
• Flux	Rosin flux containing small amount of chlorine (The flux with a
	maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over $100^\circ C$

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

USAGE CAUTIONS

- 1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
- 2. Board designing
 - (1) By-pass capacitor of more than 0.1 μ F is used between Vcc and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
 - (2) In older to avoid malfunctions and characteristics degradation, IGBT collector or emitter traces should not be closed to the LED input.
- 3. Make sure the rise/fall time of the forward current is 0.5 μ s or less.
- 4. In order to avoid malfunctions, make sure the rise/fall slope of the supply voltage is $3 V/\mu s$ or less.
- 5. Avoid storage at a high temperature and high humidity.

SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Parameter		Speck	Unit
Application classification (DIN EN 60664-1 VDE0110 for rated line voltages \leq 300 Vr.m.s. for rated line voltages \leq 600 Vr.m.s.		IV III		
Climatic test class (DIN EN 60664-1 VDE0110)			55/100/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for $U_{pr} = 1.5 \times U_{IORM}$, Pd < 5 pC	type test and random test)	Uiorm Upr	1 130 1 695	V _{peak} V _{peak}
Test voltage (partial discharge test, procedure b for a U_{pr} = 1.875 \times U_{IORM}, P_{d} $< 5~pC$	all devices)	Upr	2 119	V_{peak}
Highest permissible overvoltage		Utr	8 000	Vpeak
Degree of pollution (DIN EN 60664-1 VDE0110 Part	1)		2	
Clearance distance	PS9552, PS9552L3		>7.0	mm
	PS9552L1, PS9552L2		>8.0	
Creepage distance	PS9552, PS9552L3		>7.0	mm
	PS9552L1, PS9552L2		>8.0	
Comparative tracking index (DIN IEC 112/VDE 0303	Part 1)	СТІ	175	
Material group (DIN EN 60664-1 VDE0110 Part 1)			lli a	
Storage temperature range		Tstg	-55 to +125	°C
Operating temperature range		TA	-40 to +100	°C
Isolation resistance, minimum value V _{I0} = 500 V dc at T _A = 25°C V _{I0} = 500 V dc at T _A MAX. at least 100°C	Ris MIN. Ris MIN.	10 ¹² 10 ¹¹	Ω Ω	
Safety maximum ratings (maximum permissible in ca derating curve)	T .:	475	20	
Package temperature Current (input current Ir, Psi = 0)	Tsi Isi	175 400	°C mA	
Power (output or total power dissipation)		Psi	700	mW
Isolation resistance			10 ⁹	0
$V_{IO} = 500 \text{ V dc at } T_A = Tsi$		Ris MIN.	10	Ω

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M8E 02.11-1

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	 Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
	2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
	• Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or in any way allow it to enter the mouth.



Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)	Concentratio in CEL	
Lead (Pb)	< 1000 PPM	-A -AZ Not Detected (*)	
Mercury	< 1000 PPM	Not Detected	
Cadmium	< 100 PPM	Not Detected	
Hexavalent Chromium	< 1000 PPM	Not Detected	
РВВ	< 1000 PPM	Not Detected	
PBDE	< 1000 PPM	Not Detected	

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

In no event shall CEL's liability arising out of such information exceed the total purchase price of the CEL part(s) at issue sold by CEL to customer on an annual basis.

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